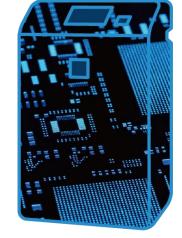
Air Cleaner

Solution Proposal by Toshiba









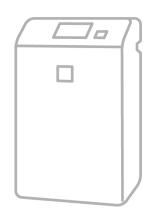




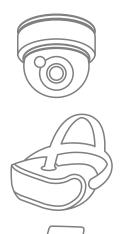








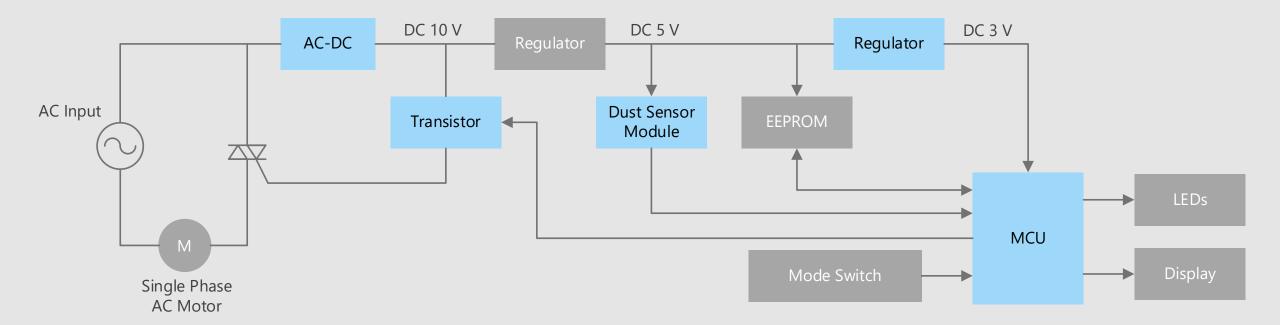
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Block Diagram

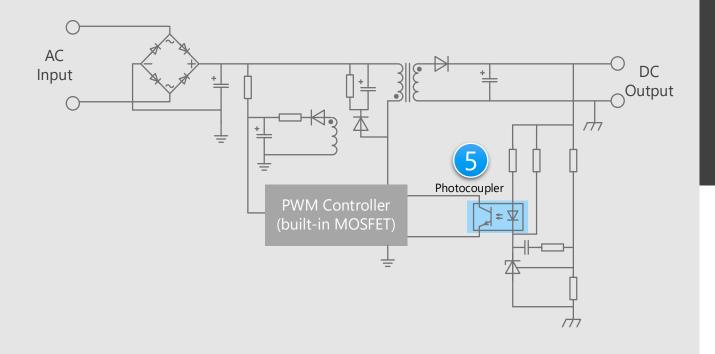
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Air Cleaner Overall block diagram



Air Cleaner Detail of power supply unit

Flyback type AC-DC converter circuit



Criteria for device selection

- A photocoupler with high current transfer ratio in the low input current range contributes to high power supply efficiency.
- Small package products contribute to the reduction of circuit board area.

Proposals from Toshiba

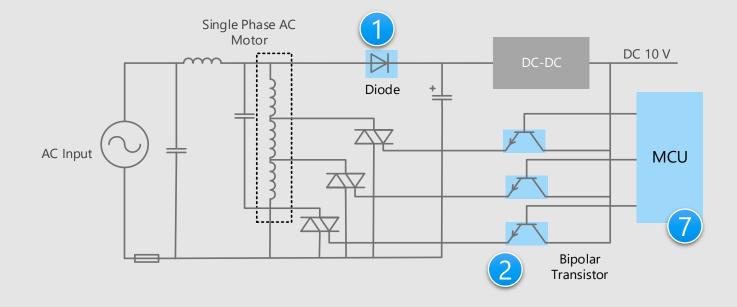
 High current transfer ratio and high temperature operation are realized Transistor output photocoupler



* Click the number in the circuit diagram to jump to the detailed description page

Air Cleaner Detail of main motor unit (1)

Main motor drive unit (When AC motor is used)



* Click the number in the circuit diagram to jump to the detailed description page

Criteria for device selection

- Small package products contribute to the reduction of circuit board area.
- Stable motor driving can be realized by using bipolar transistors, which have higher ESD tolerance than MOSFET.

Proposals from Toshiba

- **Suitable for rectification**Rectifier diode
- Suitable for use in small current switches
 Bipolar transistor
- System control at low power consumption with analog interfaces
 MCU TMPM036FWFG / TMPM037FWUG

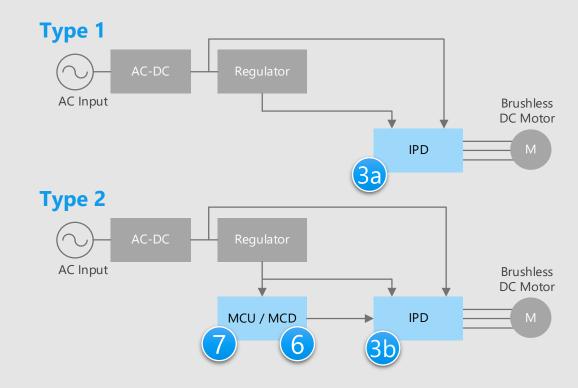






Air Cleaner Detail of main motor unit (2)

Main motor drive unit (When brushless DC motor is used)



* Click the number in the circuit diagram to jump to the detailed description page

Criteria for device selection

- The use of IPD enables direct variable speed driving of brushless DC motors.
- Brushless DC motor controller allows easy control of three-phase brushless DC motor using inverter control.
- Small package products contribute to the reduction of circuit board area.

Proposals from Toshiba

- High voltage motor can be driven
 High voltage IPD
- Easy motor control
 Brushless DC motor controller IC
- System control at low power consumption with analog interfaces

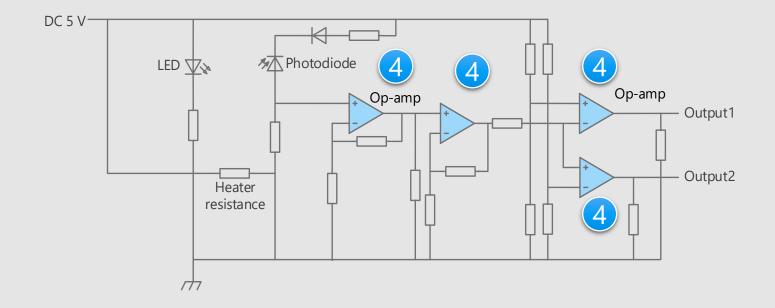
MCU TMPM036FWFG / TMPM037FWUG





Air Cleaner Detail of dust sensor unit

Dust sensor section



* Click the number in the circuit diagram to jump to the detailed description page

Criteria for device selection

- Small package products contribute to the reduction of circuit board area.
- Low noise operational amplifiers are suitable for high precision sensing.

Proposals from Toshiba

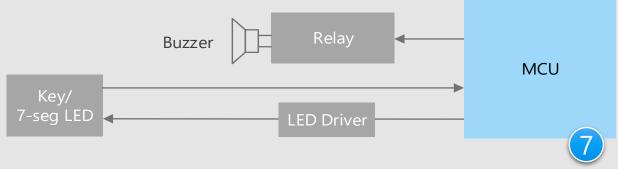
Amplify the detected very small signal with low noise

Low current consumption op-amp / Low noise op-amp

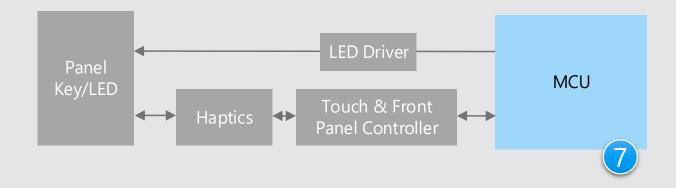


Air Cleaner Detail of operation unit

Operation unit (Example of Key/LED)



Operation unit (Example of touch panel)



* Click the number in the circuit diagram to jump to the detailed description page.

Criteria for device selection

 An MCU which has analog interfaces with low power consumption is suitable for monitoring of various sensors and system control.

Proposals from Toshiba

System control at low power consumption with analog interfaces

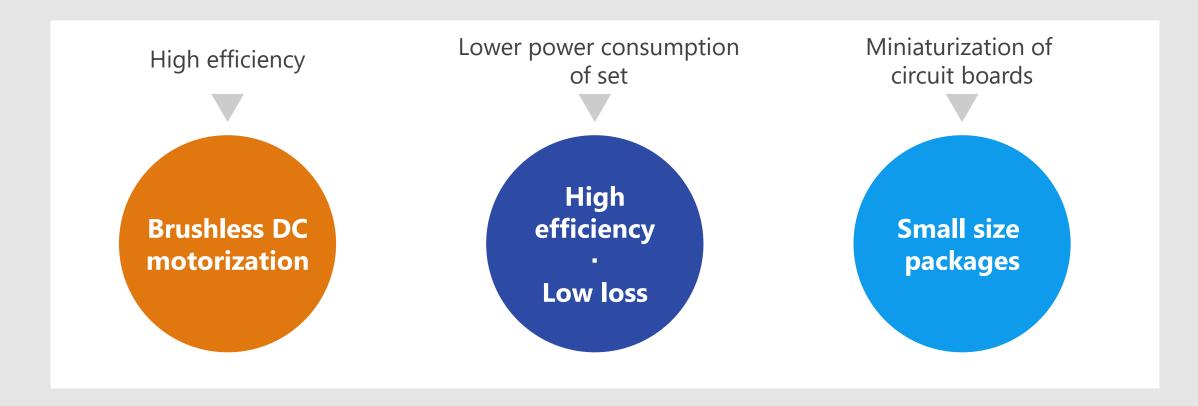
MCU TMPM036FWFG / TMPM037FWUG



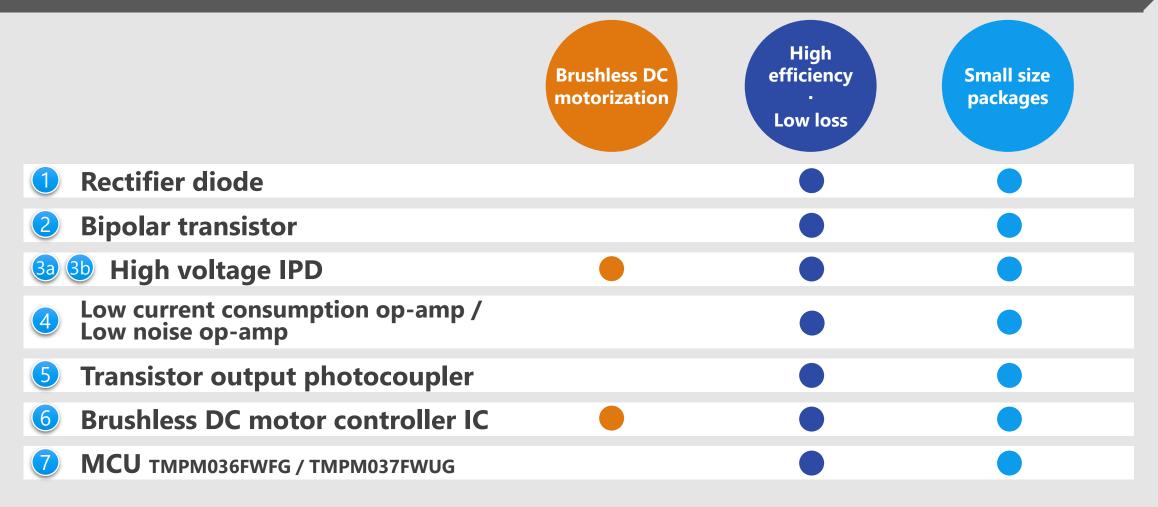


Device solutions to address customer needs

As described above, in the design of Air Cleaner, "High efficiency", "Low power consumption of set" and "Miniaturization of circuit boards" are important factors. Toshiba's proposals are based on these three solution perspectives.



Device solutions to address customer needs



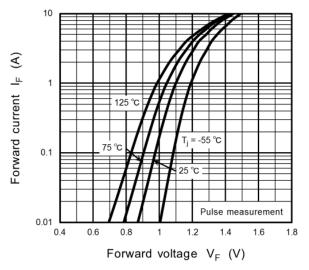


Wide range of products are provided, mainly small package that is suitable for high density assembly.

Surface mount / small package

The use of M-FLATTM packages contributes to the reduction of height and space saving of equipment compared to previous lead type devices ^[Note].

[Note] Comparison with Toshiba's products



CMG06A forward characteristic

Wide product lineup

A lineup of repetitive peak reverse voltages of 200 to 1000 V and average forward current of 0.5 to 3 A is available, enabling the selection of devices according to requirements.

Lineup			
Part number	CMG06A		
Package	M-FLAT TM		
I _{F(AV)} [A]	1		
V _{RRM} [V]	600		



With wide product lineup, Toshiba provides products that meet the needs of customers.

Wide package lineup

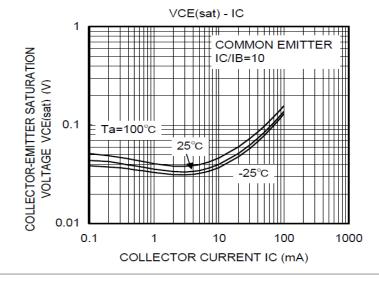
A large number of packages, such as flat lead and leadless, are available, allowing to choose products that suit circuit boards of the set.

2 Low collector-emitter saturation voltage

The low saturation voltage between the collector and emitter realize lower power consumption.

3 High ESD resistance

In applications where static electricity is likely to occur, such as air cleaners, bipolar transistors with higher ESD resistance than MOSFET are needed.



Lineup			
Part number	2SC6026CT		
Туре	NPN		
Package	CST3		
V _{CEO} [V]	50		
I _C [mA]	100		







This product optimizes for brushless DC motor driving and has the functions required for motor driving into one package.

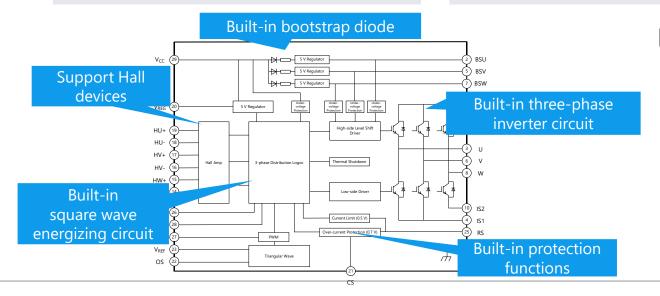
Contributing to low power consumption

The power consumption can be reduced by replacing from the AC motor to a brushless DC motor.

Contributing to reducing the number of parts

Built-in functions and protection functions required for inverter operation can reduce the number of parts. Contributing to reduction of circuit board area

The use of small surface mount packages contributes to the reduction of circuit board area.



Lineup			
Part number	TPD4162F		
Package	P-HSSOP31-0918-0.80-002		
V _{BB} [V]	600		
I _{out} [A]	0.7		
V _{CC} (Max) [V]	17.5		
Protective function	Current limitation, overcurrent protection, thermal shutdown, under voltage protection		







A brushless DC motor driver with a built-in MOSFET can be driven at a variable speed by control signals from the MCU.

Built-in circuit required to drive the motor

It contains a level shifting high side driver, low side driver and MOSFETs or IGBTs.

TPD4204F: MOSFET output

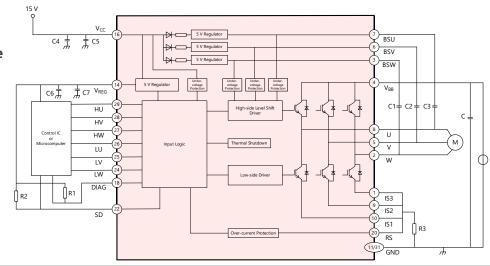
TPD4163F/TPD4163K/TPD4164F/TPD4164K: IGBT

Motor drive terminals and control terminals are separated

High voltage and large current terminals and the control terminals are separated on both sides of the package, thereby eliminating the complexity of wiring. **3** Various protection functions

Over current and under voltage protection, shutdown and thermal shutdown functions are available.

TPD4163F Application Circuit Example



output

Lineup					
Part number	TPD4204F	TPD4163F	TPD4164F	TPD4163K	TPD4164K
Package	P-SSOP30-1120-1.00-001	P-HSSOP31-0	918-0.80-002	P-HDIP30-12	233-1.78-001
V _{BB} [V]	600				
I _{out} [A]	2.5	1.0	2.0	1.0	2.0
V _{CC} [V]	13.5 to 16.5				



Lineup includes low current consumption type that contributes to low power consumption and a low noise type that maximizes the performance of high performance sensors.

Low voltage operation

We have a lineup of low power supply voltage-driven operational amplifiers using CMOS process for low power supply voltage-driven wearable equipment.

Low current consumption
(TC75S102F) I_{DD} = 0.27 [μΑ] (Typ.)

CMOS processes have been used to achieve lower current consumption. This contributes to lower power consumption and longer life of wearable equipment.

Low noise (TC75S67TU)

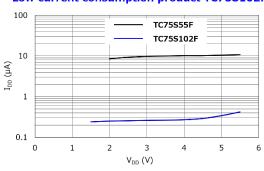
V_{NI} = 6.0 [nV/√Hz] (Typ.) @f = 1 kHz

This CMOS operational amplifier can amplify minute signals detected by various sensors [Note] with low noises. By optimizing the process, the equivalent input noise voltage has been reduced.

TC75S102F

Current Consumption Characteristic (Toshiba internal comparison)

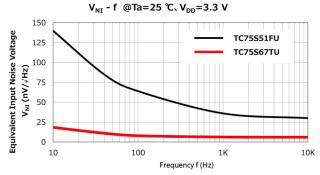
Low current consumption product TC75S102F



TC75S67TU

Noise Characteristic (Toshiba internal comparison)

Reduce 1/f noise (10 Hz) by 86 % from our normal products



[Note] Sensor types: vibration, shock, acceleration, pressure, infrared, temperature, etc.

Lineup				
Part number	TC75S102F	TC75S67TU		
Package	SMV	UFV		
V _{DD} - V _{SS} [V]	1.5 to 5.5	2.2 to 5.5		
V _{IO} (Max) [mV]	1.3	3		
CMV _{IN} (Max) [V]	V_{DD}	1.4 (@V _{DD} = 2.5 V)		
I _{DD} (Typ. / Max) [μA]	0.27 / 0.46 (@V _{DD} = 1.5 V)	430 / 700 (@V _{DD} = 2.5 V)		
V _{NI} (Typ.) [nV/√Hz] @f = 1 kHz	-	6		

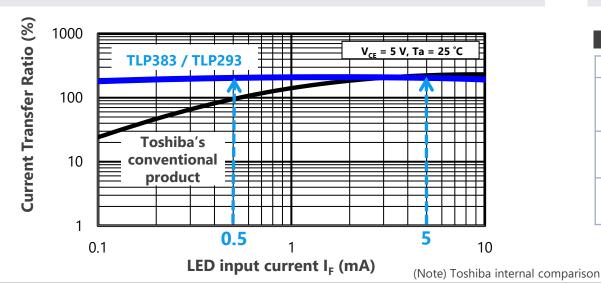
Transistor output photocoupler

Value provided

High CTR (Current Transfer Ratio) is realized even in low input current range ($I_F = 0.5 \text{ mA}$).

High current transfer ratio

The TLP383 and TLP293 is a high isolation photocoupler that optically couples a phototransistor and high output infrared LED. Compared to Toshiba's conventional products (TLP385), higher CTR (Current Transfer Ratio) in low input current range ($@I_F = 0.5$ mA) is realized.



High temperature operation

The TLP383 and TLP293 are designed to operate even under severe ambient temperature conditions.

Lineup				
Part number	TLP383 TLP293		TLP385	
Package	4pin SO6L	SO4	4pin SO6L	
BV _S [Vrms]	5000	3750	5000	
T _{opr} [°C]	-55 to 125	-55 to 125	-55 to 110	



Small size packages

Value provided

By using IPD externally to the controller, high voltage and high current brushless DC motor drive is realized.

Efficient motor control using auto lead angle control

In addition to fixed angle control using voltage input (32 steps), auto lead angle control using current feedback is possible.

Motor control with low noise and low vibration

(TB6584FNG, TB6584AFNG)

Sine wave drive system with smooth current waveforms contributes to lower motor noise and vibration compared to conventional square wave drive system [Note].

[Note] Comparison with Toshiba products

Full development support

Third party evaluation boards and PSpice® data can be provided to support customer development and design.

TB6584FNG, TB6584AFNG



Package: SSOP30-P-300-0.65 (10.2 x 7.6 x 1.6 mm)

Lineup					
	Part number	TB6584FNG	TB6584AFNG	TB6586AFG	
	V _{CC} [V]	e mode Sine wave drive Lead angle control: Auto phase control (current feedback) Sensor input: Hall device/Hall IC compatible Internal regulator: 5 V, 30 mA (Max) Error detection: Overcurrent protection		6.5 to 16.5	
	I _{OUT} [A]			0.003	
	Drive mode			Square wave drive	
	Features			Lead angle control: External input Sensor input: Hall device/Hall IC compatible Internal regulator: 5 V, 35 mA (Max) Error detection: Overcurrent protection, position signal error, low voltage	



It contributes to system cost down, high efficiency system and development efficiency improvement.

Built-in Arm® Cortex®-M0 CPU core

Built-in Arm Cortex-M0 core with Arm® Thumb® instruction set improves energy efficiency. Various development tool and their partners allow users many options.

Suitable for sensing analog signal

Built-in multichannel AD converter executes sensing data processing efficiently at low cost.

Small package and low power consumption

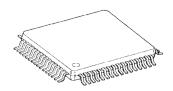
Cortex-M0 and Toshiba original NANO FLASH™ technology bring to the small package and low power consumption. They contribute to reduce circuit board area and power consumption.

TMPM036FWFG



Package: LQFP100-P-1414-0.50H

TMPM037FWUG



Package: LQFP64-P-1010-0.50E

Lineup

·		
Part number	TMPM036FWFG	TMPM037FWUG
Maximum operation frequency	20 MHz	20 MHz
Instruction ROM	128 KB	128 KB
RAM	16 KB	16 KB
Timer	14ch	10ch
UART / SIO	6	5
I ² C	2	1
AD converter	8ch (10bit)	8ch (10bit)

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